

FracFM™ (NN01-055) – Mobile FM Antenna

Fractus Antennas specializes in enabling effective mobile communications. Using Fractus technology, we design and manufacture optimized antennas to make your wireless devices more competitive. Our mission is to help our clients develop innovative products and accelerate their time to market through our expertise in antenna design, testing and manufacturing.



FracFM™

NN01-055

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Fractus Antennas is an ISO 9001:2015 certified company. All our antennas are lead-free and RoHS compliant.

ISO 9001: 2015 Certified



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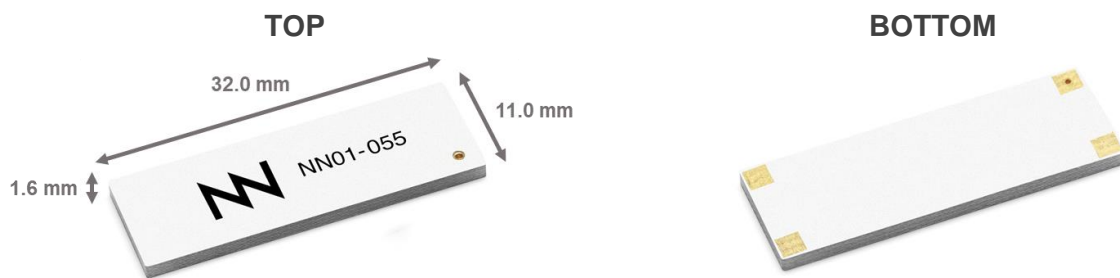
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1. ANTENNA DESCRIPTION

The FracFM™ is an off-the-shelf internal antenna solution specifically designed for general handheld devices and applications operating in the FM band.

FracFM™ minimizes your product development cost and time. With its compact size and high performance, the FracFM™ internal antenna is the optimal choice for your portable FM application.

With its superior performance, small form factor, modularity and high isolation, the FracFM™ antenna solution meets and exceeds all your customer requirements for an internal compact and modular antenna.



Material: The FracFM™ antenna is built on glass epoxy substrate.

APPLICATIONS

- Personal Media Player (PMP)
- Ultra Mobile PC (UMPC)
- Private Mobile Radio (PMR) (Walkie Talkie)
- Laptops

BENEFITS

- Reduced Form Factor
- Modularity - SMD
- Superior Performance
- Easy to use (pick and place)

2. QUICK REFERENCE GUIDE

Technical Features	78 – 108 MHz
Gain Curve	See page 7
Radiation Pattern	Omnidirectional
Polarization	Linear
Flatness	< 2 dB gain variation
Weight (approx.)	1.1 g
Temperature	-40 to +125 °C
Impedance	50 Ω
Dimensions(L x W x H)	32.0 mm x 11.0 mm x 1.6 mm

Table 1 – Technical Features. Measures from the evaluation board. See Figure 1.

Please contact support@fractusantennas.com if you require additional information on antenna integration or optimization on your PCB.

3. ELECTRICAL PERFORMANCE

3.1. EVALUATION BOARD

The configuration used in testing the FracFM™ antenna is displayed in Figure 1.

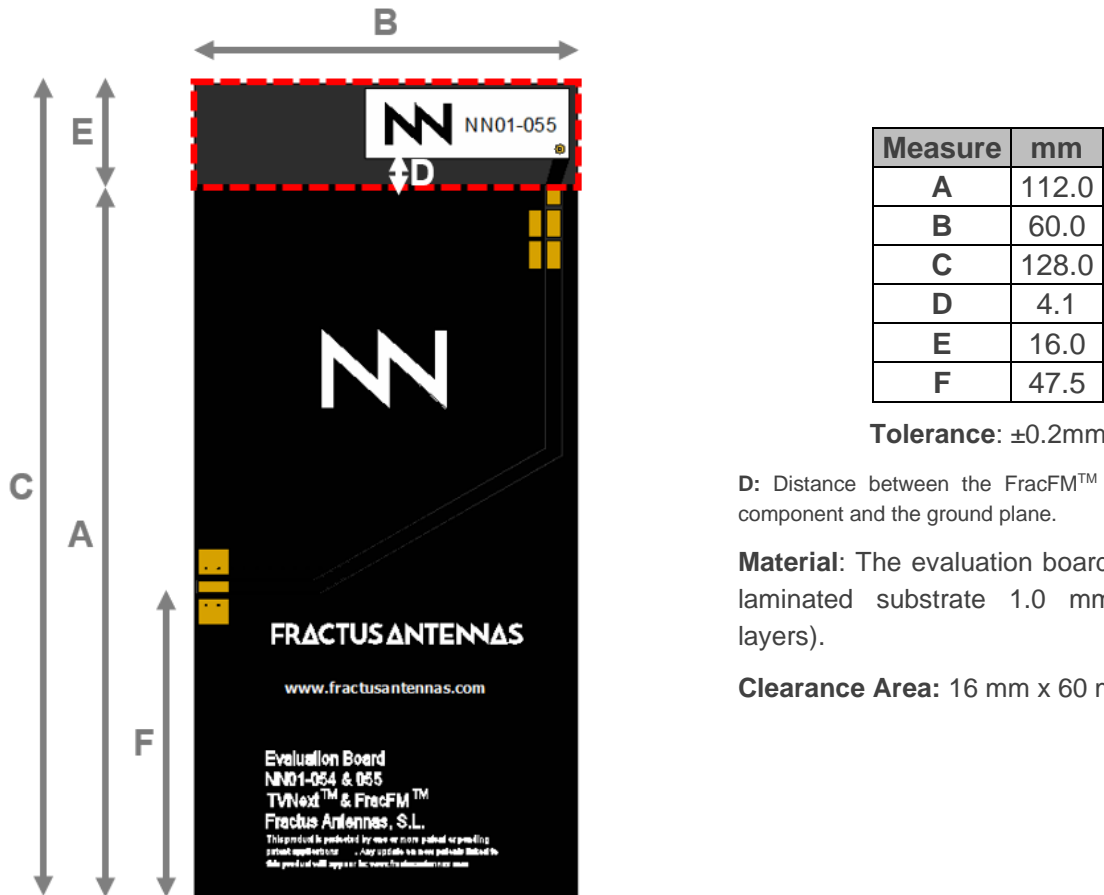


Figure 1 – EB_NN01-055. FracFM™ Evaluation Board.

3.2. MATCHING NETWORK

The specs of a Fractus Antennas standard antenna are measured in their evaluation board, which is an ideal case. In a real design, components nearby the antenna, LCD's, batteries, covers, connectors, etc. affect the antenna performance. This is the reason why it is highly recommended placing pads compatible with 0402 and 0603 SMD components for a PI matching network as close as possible to the antenna feeding point. Do it in the ground plane area, not in the clearance area. This is a degree of freedom to tune the antenna once the design is finished and considering all elements of the system (batteries, displays, covers, etc.).

Please notice that different devices with different ground planes and different components nearby the FracFM™ chip antenna may need a different matching network. To ensure optimal results, the use of high Q and tight tolerance components is highly recommended (Murata components). If you need assistance to design your matching network beyond this application note, please contact support@fractusantennas.com, or try our free-of-charge¹ **NN Wireless**

Fast-Track design service, you will get your chip antenna design including a custom matching network for your device in 24h¹. Other related to NN’s range of R&D services is available at: <https://www.fractusantennas.com/rdservices/>

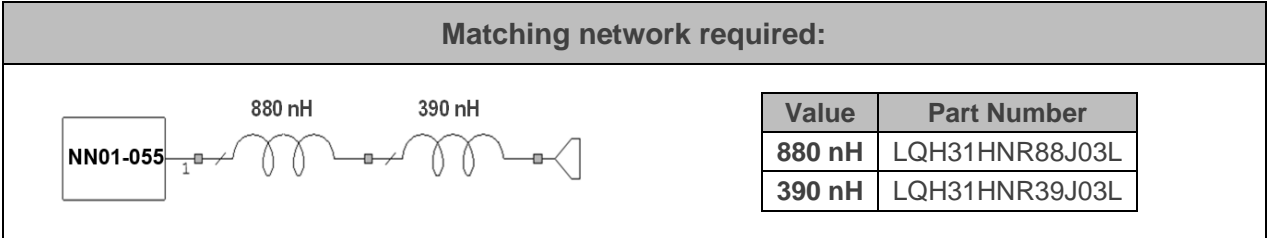


Figure 2 – Matching network implemented in the Evaluation Board.

¹ See terms and conditions for a free NN Wireless Fast-Track service in 24h at: <https://www.fractusantennas.com/fast-track-project/>

3.3. RADIATION PATTERNS AND GAIN

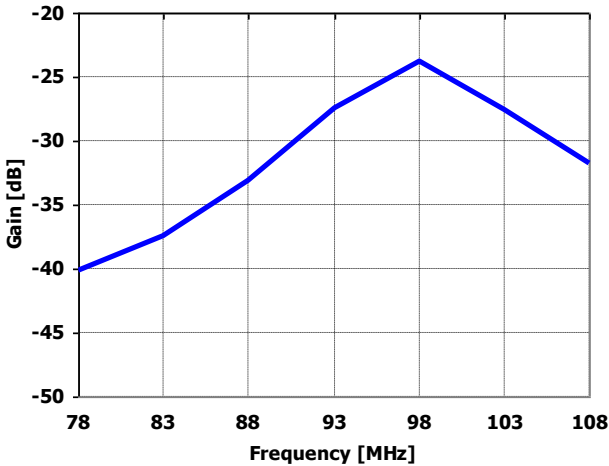
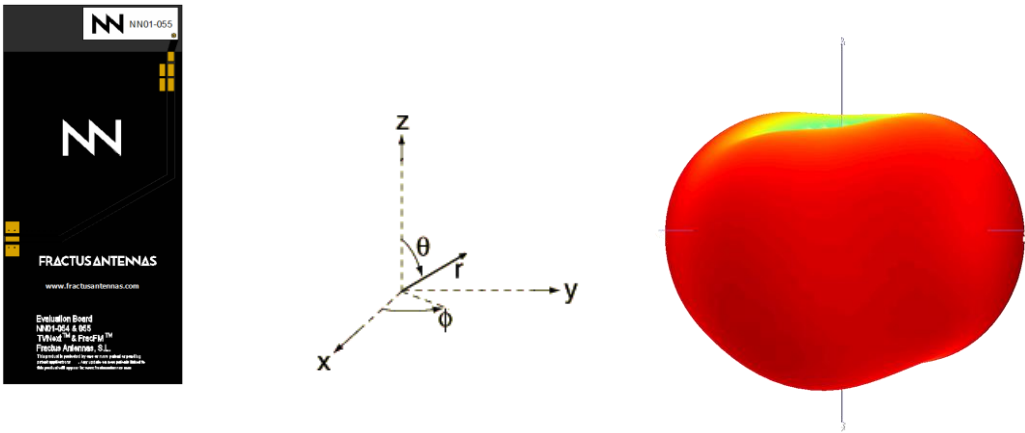
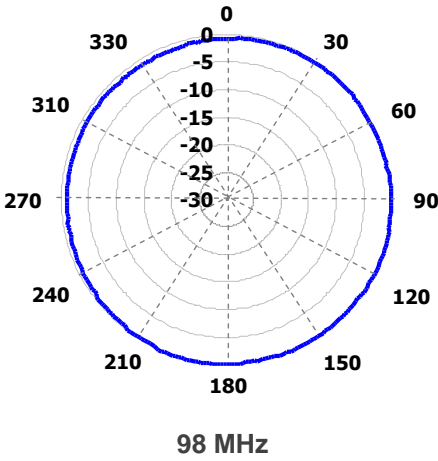
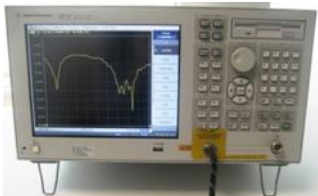
GAIN	<div>  <p>Note: Please notify that this antenna is designed for reception.</p> </div>
Radiation Pattern	<div>  </div>
Radiation Pattern	<div>  </div>

Table 2 – Typical antenna Gain across FM bandwidth.

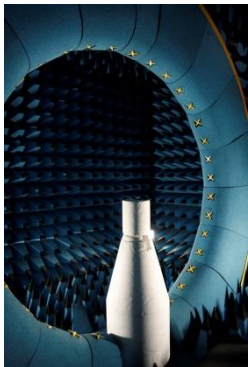
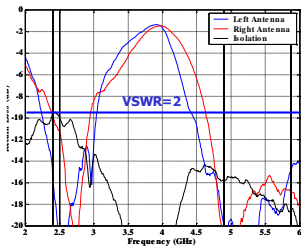
3.4. CAPABILITIES AND MEASUREMENT SYSTEMS

Fractus Antennas specializes in the design and manufacture of optimized antennas for wireless applications, and with the provision of RF expertise to a wide range of clients. We offer turn-key antenna products and antenna integration support to minimize your time requirements and maximize return on investment throughout the product development process. We also provide our clients with the opportunity to leverage our in-house testing and measurement facilities to obtain accurate results quickly and efficiently.



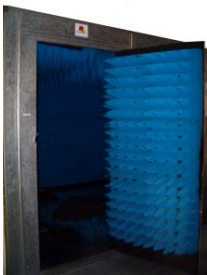
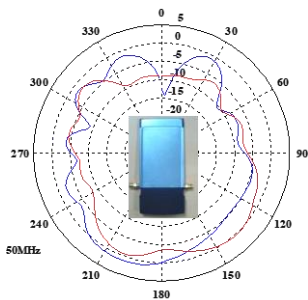
Agilent E5071B

VSWR
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 S Parameters



SATIMO STARGATE 32

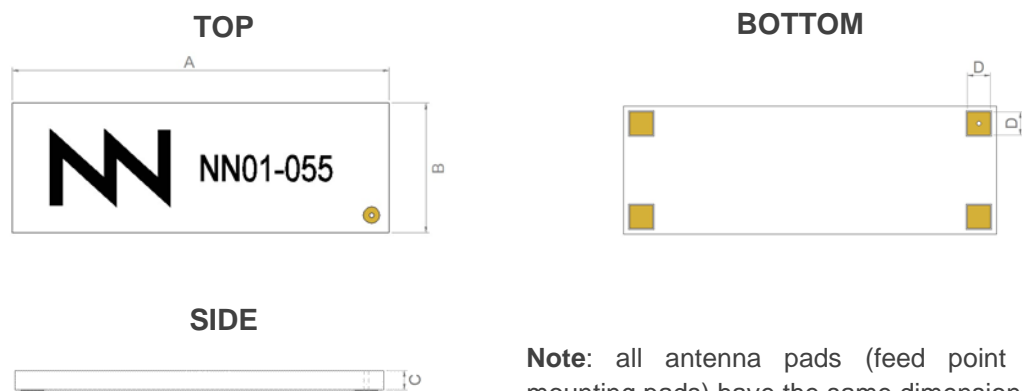
Radiation
 Pattern
 &
 Efficiency



Anechoic chambers and full equipped in-house lab

4. MECHANICAL CHARACTERISTICS

4.1. DIMENSIONS AND TOLERANCES



The yellow circle on the front of the antenna provides a visual cue to mounting the antenna. It is located above the feed point of the antenna and is included to decrease possible manufacturing error.

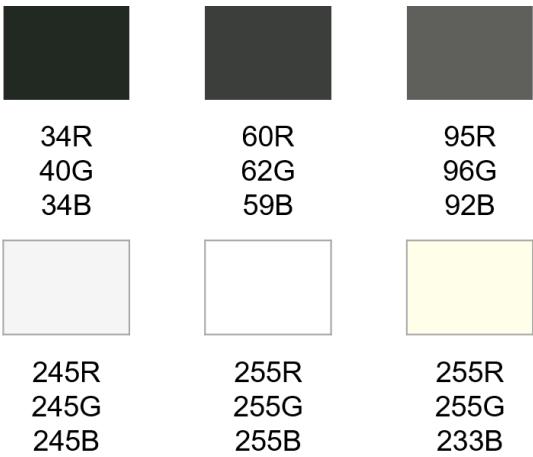
Measure	mm	Measure	mm
A	32.0 ± 0.2	C	1.6 ± 0.2
B	11.0 ± 0.2	D	2.0 ± 0.1

Figure 3 – Antenna Dimensions and Tolerances.

The FracFM™ antenna is compliant with the restriction of the use of hazardous substances (RoHS).

4.2. SPECIFICATIONS FOR THE INK

Next figure shows the correct colors of the antenna:



Acceptable color range

4.3. ANTENNA FOOTPRINT

This antenna footprint applies for the reference evaluation board described on page 5 of this User Manual.

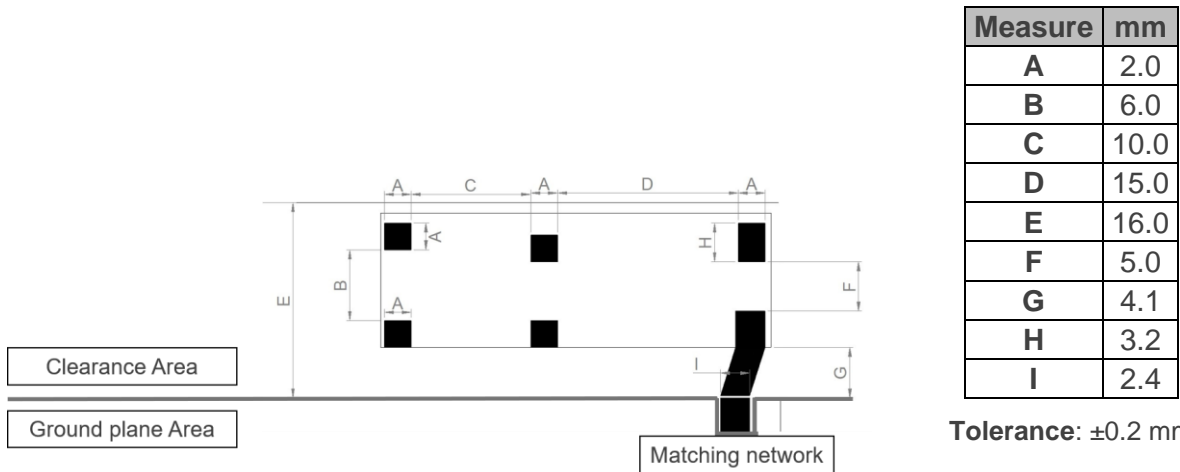


Figure 4 – Antenna Footprint Details.

Other PCB form factors and configurations may require a different feeding configuration, feeding line dimensions and clearance areas. If you require support for the integration of the antenna in your design, please contact support@fractusantennas.com

ASSEMBLY PROCESS Figure 5 shows the back and front view of the FracFM™ antenna, and indicates the location of the feeding point and the mounting pads:

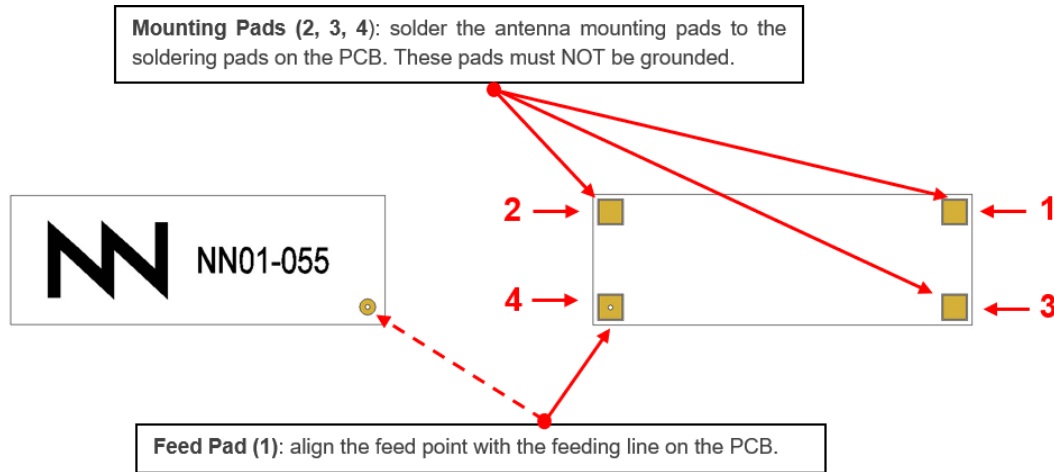


Figure 5 – Pads of the FracFM™ chip antenna.

As a surface mount device (SMD), this antenna is compatible with industry standard soldering processes. The basic assembly procedure for this antenna is as follows:

1. Apply a solder paste to the pads of the PCB. Place the antenna on the board.
2. Perform a reflow process according to the temperature profile detailed in Table 3, Figure 7 on page 12.
3. After soldering the antenna to the circuit board, perform a cleaning process to remove any residual flux. Fractus Antennas recommends conducting a visual inspection after the cleaning process to verify that all reflux has been removed.

The drawing below shows the soldering details obtained after a correct assembly process:

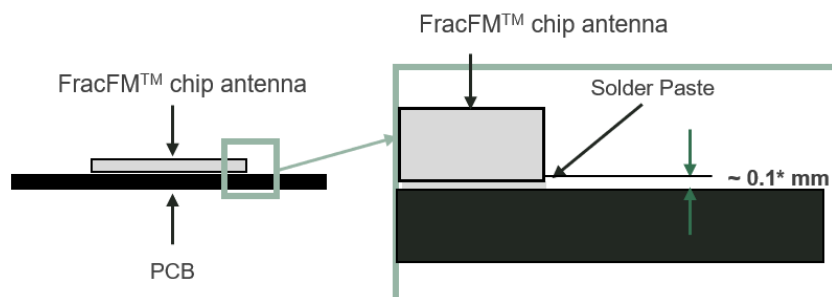


Figure 6 – Soldering Details.

NOTE(*): Solder paste thickness after the assembly process will depend on the thickness of the soldering stencil mask. A stencil thickness equal to or larger than **127 microns (5 mils)** is required.

The FracFM™ antenna should be assembled following either Sn-Pb or Pb-free assembly processes. According to the Standard **IPC/JEDEC J-STD-020C**, the temperature profile suggested is as follows:

Phase	Profile features	Pb-Free Assembly (SnAgCu)
RAMP-UP	Avg. Ramp-up Rate (T _{smax} to T _p)	3 °C / second (max.)
PREHEAT	<ul style="list-style-type: none"> - Temperature Min (T_{smin}) - Temperature Max (T_{smax}) - Time (t_{smin} to t_{smax}) 	150 °C 200 °C 60-180 seconds
REFLOW	<ul style="list-style-type: none"> - Temperature (T_L) - Total Time above T_L (t_L) 	217 °C 60-150 seconds
PEAK	<ul style="list-style-type: none"> - Temperature (T_p) - Time (t_p) 	260 °C 20-40 seconds
RAMP-DOWN	Rate	6 °C/second max
Time from 25 °C to Peak Temperature		8 minutes max

Table 3 – Recommended soldering temperatures.

Next graphic shows temperature profile (grey zone) for the antenna assembly process in reflow ovens.

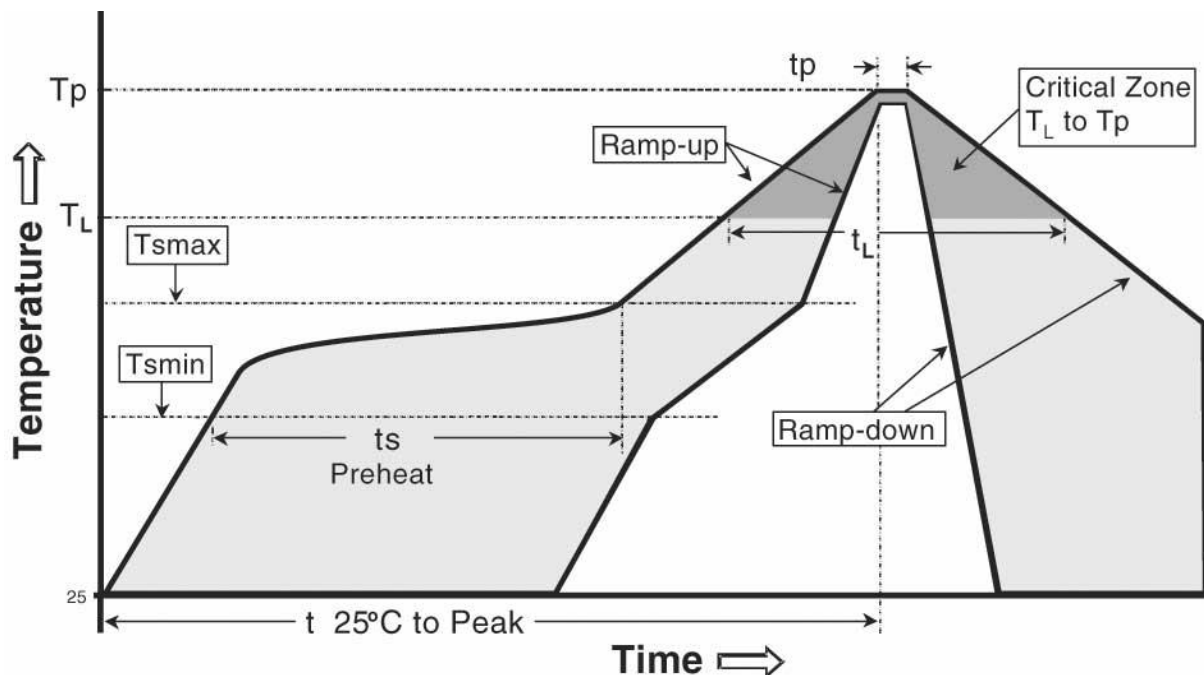


Figure 7 – Temperature profile.

5. PACKAGING

The FracFM™ chip antenna is available in tape and reel packaging.

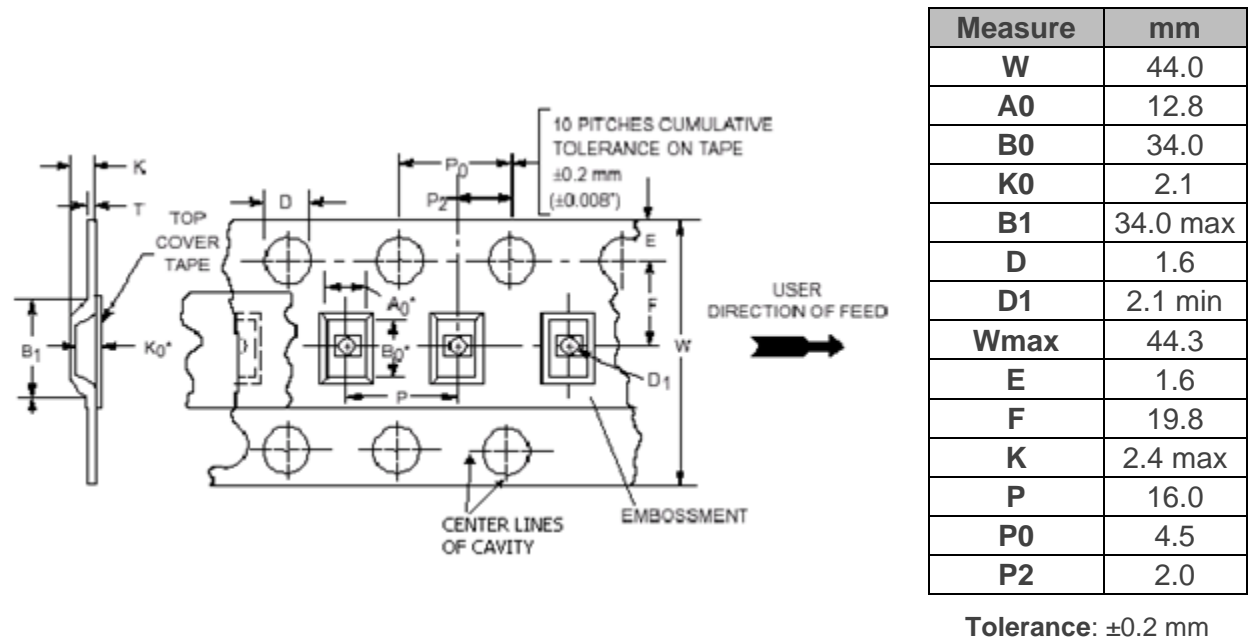


Figure 8 – Tape Dimensions.

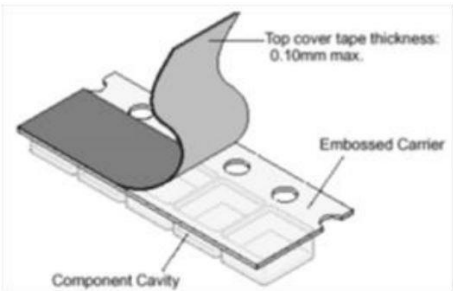


Figure 9 – Image of the tape.

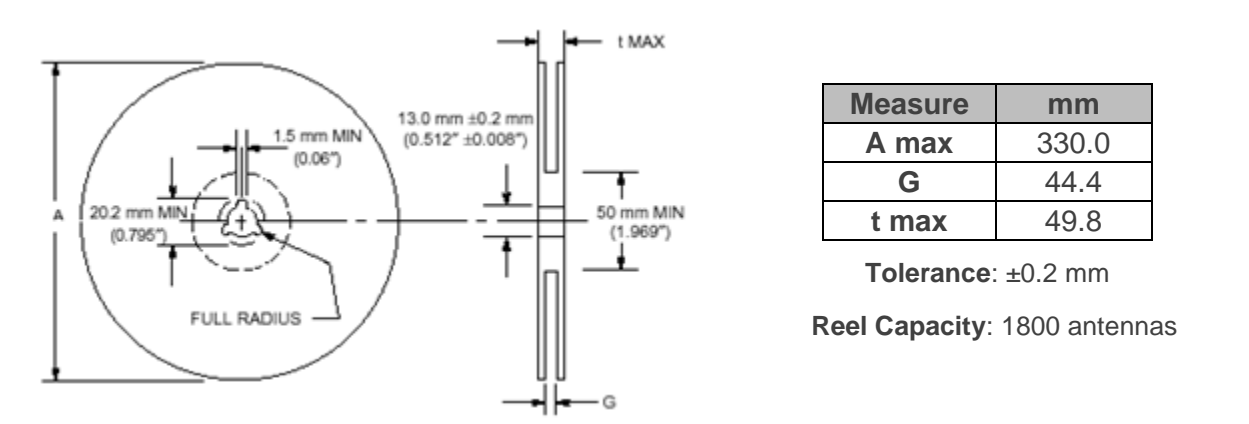


Figure 10 – Reel Dimensions and Capacity.

6. PRODUCT CHANGE NOTIFICATION

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PCN Number: NN19100009

Notification Date: October 07th, 2019

Part Number identification:

Part Number changes, it will be applied in all the document of the company (User Manual, Data Sheet, ...)

Previous Part Number
FR01-B3-W-0-055

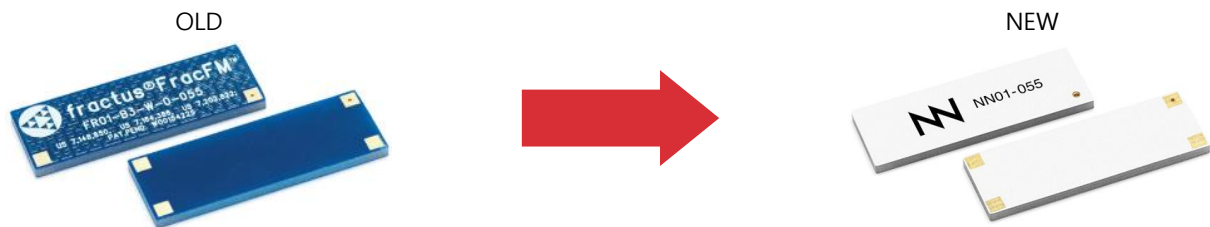
New Part Number
NN01-055

Reason for change:

<input type="checkbox"/>	Specs (electrical/mechanical)	<input type="checkbox"/>	Manufacturing location
<input type="checkbox"/>	User Manual/Data Sheet	<input type="checkbox"/>	Quality/Reliability
<input type="checkbox"/>	Material/Composition	<input type="checkbox"/>	Logistics
<input type="checkbox"/>	Processing/Manufacturing	<input checked="" type="checkbox"/>	Other: Logo, product color and Part Number

Change description

- 1.- Part Number: From FR01-B3-W-0-055 FRACTUS to NN01-055 FRACTUS ANTENNAS in the User Manual
- 2.- Color: From blue/white to white/black



Comments:

- 1.- Electrical and Mechanical specs remain the same
- 2.- Footprint in the PCB to solder the chip antenna remains the same

Identification method

- 1.- In the chip antennas, the changes are in the color, in the logo and in the part number

User Manual	<input checked="" type="checkbox"/>	Available from: May 2020
Samples	<input checked="" type="checkbox"/>	Available from: January 2021

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